



DMPH6023SK3Q

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
	$33m\Omega @ V_{GS} = -10V$	-35A
-60V	40mΩ @ V _{GS} = -4.5V	-32A

Description and Applications

This MOSFET has been designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

60V 175°C P-CHANNEL ENHANCEMENT MODE MOSFET

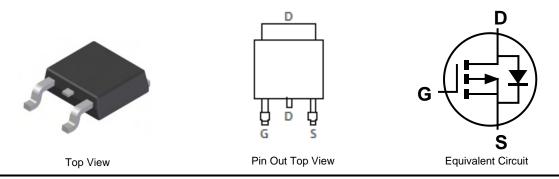
Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low On-Resistance
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🔞
- Terminal Connections: See Diagram
- Weight: 0.33 grams (Approximate)

TO252 (DPAK)



Ordering Information (Note 5)

Part Number	Case	Packaging
DMPH6023SK3Q-13	TO252 (DPAK)	2,500/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

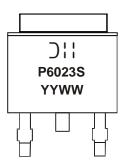
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



) | | =Manufacturer's Marking P6023S = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 = 2016) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-60	V		
Gate-Source Voltage			V _{GSS}	±20	V
	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	ID	-35 -27	А
Continuous Drain Current (Note 7) $V_{GS} = -10V$	Steady State	T _A = +25°C T _A = +70°C	ID	-7.3 -6.1	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)			IDM	-60	A
Maximum Continuous Body Diode Forward Current (Note 7)			Is	-2.2	A
Avalanche Current (Note 8) L = 0.1mH			I _{AS}	-35	A
Avalanche Energy (Note 8) L = 0.1mH			E _{AS}	60	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	PD	2.0	W	
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	80	°C/W	
Total Power Dissipation (Note 7)	PD	3.2	W	
Thermal Resistance, Junction to Ambient (Note 7) Steady State		R _{0JA}	41	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	1.6	°C/w	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)	Cymbol		i yp	max	Onic		
Drain-Source Breakdown Voltage	BV _{DSS}	-60	—		V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}		_	-1	μA	$V_{DS} = -60V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)						·	
Gate Threshold Voltage	V _{GS(TH)}	-1.0	_	-3.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance	P		—	33	mΩ	$V_{GS} = -10V, I_D = -10A$	
	R _{DS(ON)}		_	40	11152	$V_{GS} = -4.5V, I_D = -8A$	
Diode Forward Voltage	V _{SD}		-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		2,569	_	pF	N 2014 N 014	
Output Capacitance	Coss	-	179	_	pF	V _{DS} = -30V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		143	—	рF	1 - 1.00012	
Gate Resistance	Rg		5	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg		26.5	—	nC		
Total Gate Charge (V _{GS} = -10V)	Qg		53.1	—	nC	Vps = -30V. lp = -5A	
Gate-Source Charge	Q _{gs}		7.1	—	nC	$v_{DS} = -30v, I_D = -5A$	
Gate-Drain Charge	Q _{gd}		12.6	—	nC		
Turn-On Delay Time	t _{D(ON)}		6	—	ns		
Turn-On Rise Time	t _R		7.1	—	ns	$V_{GS} = -10V, V_{DS} = -30V,$	
Turn-Off Delay Time	t _{D(OFF)}		110		ns	$R_G = 3\Omega, I_D = -5A$	
Turn-Off Fall Time	tF		62	—	ns		
Body Diode Reverse Recovery Time	t _{RR}		20	_	ns		
Body Diode Reverse Recovery Charge	Q _{RR}	—	14	_	nC	I _F = -5A, di/dt = 100A/μs	

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

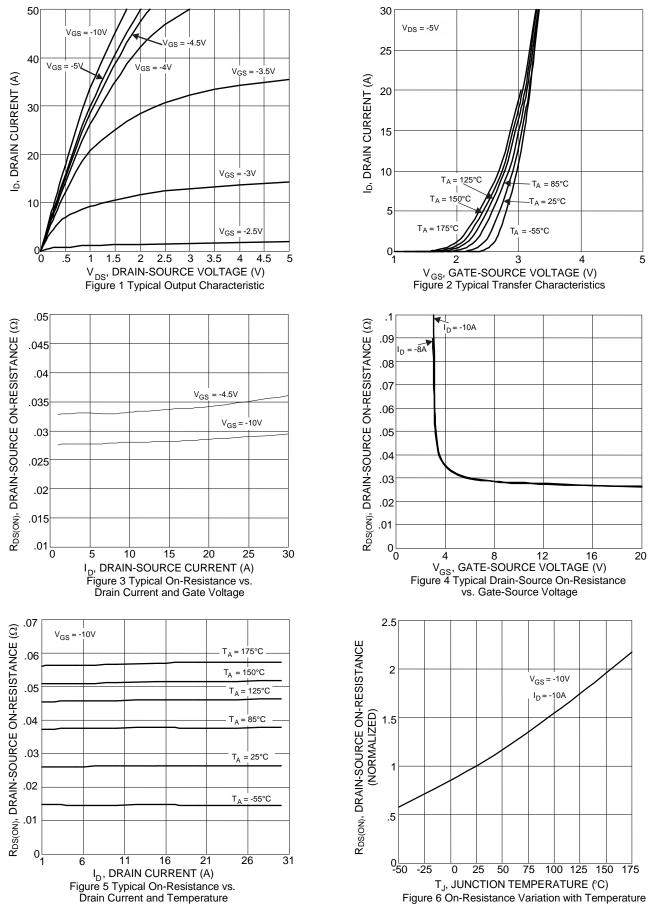
8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

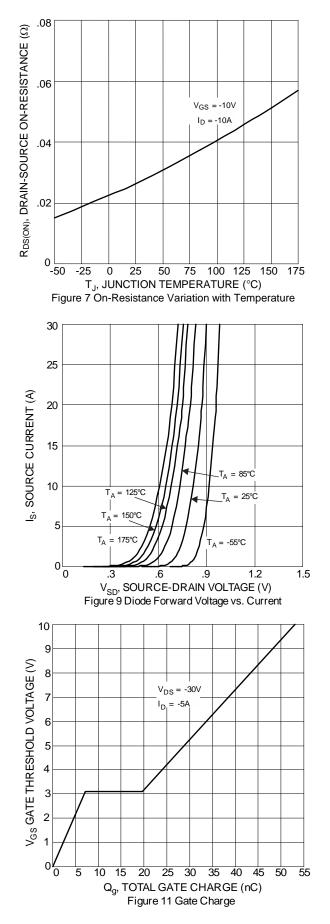


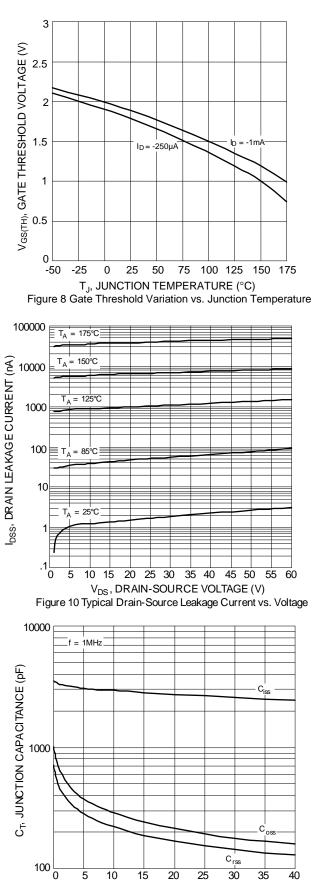




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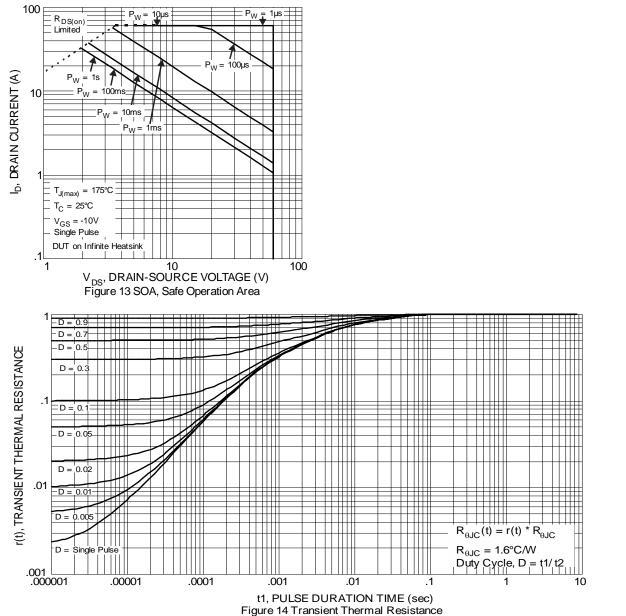






V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12 Typical Junction Capacitance



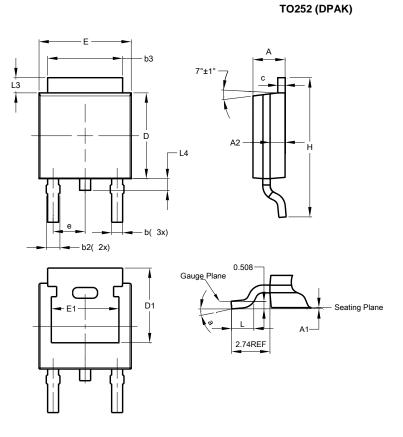


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Package Outline Dimensions

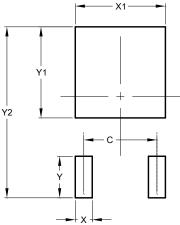
Please see http://www.diodes.com/package-outlines.html for the latest version.



TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Ε	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TO252 (DPAK)

Dimensions	Value (in mm)			
С	4.572			
Х	1.060			
X1	5.632			
Y	2.600			
Y1	5.700			
Y2	10.700			



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